

Attorney Docket No. 10120231

PATENT

## IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: **Chun-Chin CHEN, Chung-  
Hsien WU, Ting-Guang  
LIANG, Hsi-Hsin SHIH**

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Appl. No.: 10/802,715

Examiner: **GODFREY, KEITH  
JOSEPH**

Conf. No.: 5048

Art Unit: 1732

Title: **METHOD AND APPARATUS FOR PRODUCING CONTINUOUS  
EXTRUSION MOLDING**

REVOCATION OF POWER OF ATTORNEY, SUBSTITUTE POWER  
OF ATTORNEY, AND CHANGE IN CORRESPONDENCE ADDRESS

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Name and Address of Assignee: **Professionals Auto Parts International Co., Ltd.  
Chung Hsiao E. Road, Sec. 4  
9th Fl., No. 10, Alley 5, Lane 170  
Taipei, Taiwan 10646**

The assignee of record of the above-identified patent application, as evidenced by the enclosed Certificate Under 37 C.F.R. § 3.73(b) showing chain of title, hereby revokes any and all previous powers of attorney for the identified patent application, and hereby appoints the practitioner(s) at:

**Customer No. 34,283**

as the attorney(s) and/or agent(s) of the assignee to receive all correspondence relating to the identified application and to transact all business in the United States Patent and Trademark Office connected therewith, with full power of substitution and revocation.

Please change the correspondence address for the above-identified application to:

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The practitioner(s) named above are hereby authorized to act and rely on instructions from and communicate directly with the person/attorney/firm/organization who/which first sends/sent this case, unless provided with written notice to the contrary by the undersigned.

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The undersigned (whose title is supplied below) certifies that he/she is empowered to sign this Revocation and Substitute Power of Attorney on behalf of the assignee.

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

October 1, 2007

Date

  
SignatureChung-Hsien WU

Typed or printed name

President

Title